Electra House, 32 Southtown Road Great Yarmouth, Norfolk NR31 0DU, England Telephone +44 (0)1493 602602 Fax +44 (0)1493 665111 Email:sales@midasdisplays.com www.midasdisplays.com

MC21206A6W1-SPTLY	2 x 12	6mm Character Height	LCD Module						
	Specification								
Version: 4	Version: 4 Date: 13/04/2018								
	Revision								
1	27/08/2012	First Release.							
2	31/10/2014	Remove IC Information.							
3	15/12/2014	Correct Screw Hole=R1.25							
4	25/02/2016	Modify Static Electricity Test.							

Display F	eatures		
Character Count	2 x 12		
Appearance	Black on Yellow / Green		
Logic Voltage	5V		
Interface	Parallel		1
Font Set	English / Japanese		CHS
Display Mode	Transflective		ROHS ompliant
Character Height	5.50mm		omphant
LC Type	STN		
Module Size	55.70 x 32.00 x 9.70 mm		
Operating Temperature	-20°C ~ +70°C		
Construction	СОВ	Box Quantity	Weight / Display
LED Backlight	Yellow / Green		

* - For full design functionality, please use this specification in conjunction with the ST7066U specification. (Provided Separately)

Display Accessories				
Part Number	Description			

Optional Variants							
Fonts	Appearances	Voltage					
1 3113	White on Blue	Voltage					

Contents

- 1.General Specification
- 2. Module Classification Information
- 3.Interface Pin Function
- 4. Contour Drawing & Block Diagram
- 5. Character Generator ROM Pattern
- 6. Optical Characteristics
- 7. Absolute Maximum Ratings
- 8. Electrical Characteristics
- 9.Backlight Information
- 10.Reliability
- 11.Inspection specification
- 12.Precautions in use of LCD Modules
- 13. Material List of Components for RoHs
- 14.Recommendable Storage

1.General Specification

The Features is described as follow:

■ Module dimension: 55.7 x 32.0 x 9.7 (max.) mm

View area: 46.0 x 14.5 mm

Active area: 37.85 x 11.7 mm

■ Number of Characters: 12 characters x 2Lines

■ Dot size: 0.45 x 0.60 mm

■ Dot pitch: 0.55 x 0.70 mm

■ Character size: 2.65 x 5.50 mm

■ Character pitch: 3.20 x 6.20 mm

■ LCD type: STN Positive, Yellow Green Transflective

■ Duty: 1/16

■ View direction: 6 o'clock

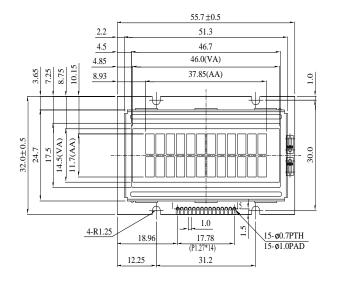
■ Backlight Type: LED, Yellow Green

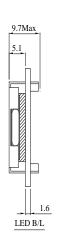
IC:ST7066Ugn • manufacture • supply

3.Interface Pin Function

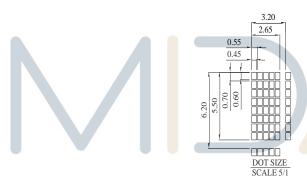
Pin No.	Symbol	Level	Description
1	Vss	0V	Ground
2	V _{DD}	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read L: Write
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	D <mark>at</mark> a bus line
12	DB5	H/L	Data bus line
13	DB6	19 H/L •	Data bus line Tacture - Supply
14	DB7	H/L	Data bus line
15	А	_	LED+

4. Contour Drawing & Block Diagram

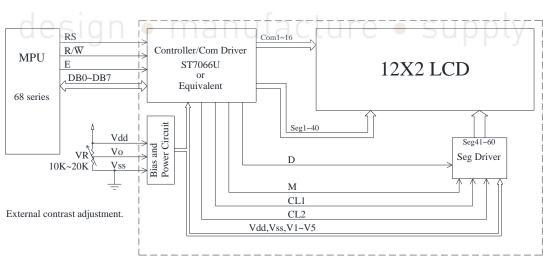




PIN NO.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	RS
5	R/W
6	Е
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	A



The non-specified tolerance of dimension is ± 0.3 mm.



Character located DDRAM address DDRAM address

1 2 3 4 5 6 7 8 9 10 11 12 00 01 02 03 04 05 06 07 08 09 0A 0B 40 41 42 43 44 45 46 47 48 49 4A 4B

5.Character Generator ROM Pattern

Table.2

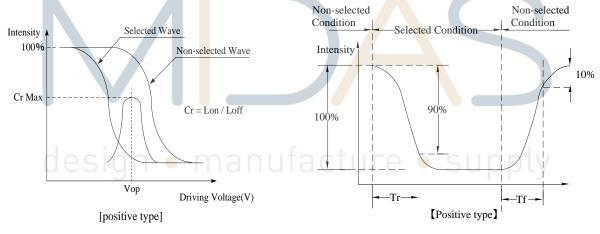
Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	нгнн	HHLL	ННГН	НННЬ	нннн
LLLL	CG RAM (1)						5 5	5555 5 5555 5				55555	5555 5 5 5 5 5 5 5	555 555 555		Characharaca Car Car Car Car Car Car Car Car Car Car Car Car
LLLH	(2)		50 50 50					55555 50 50			555 55 55 55	55555 555 555 55 55	555 555 5555 55	5 5 5 5 5 5 5 5 5 5	50 50 50 50 50	
LLHL	(3)		50 50 50 50		5 5 5 5 5 5		50 50 50 50 50 50 50 50 50 50 50	5 5 5 5 5 5 5 5			55 55 55	5 5 5	5 5 5 5 5 5 5 5 5 5 5 5 5 5	5 5 5 5 5		
LLHH	(4)		50 50 50 50 50 50 50 50 50 50 50 50 50 5	55555 55 55 55 55	5 55		555 5 5 5 5	555 555 5555			5 5 5 5 5	55 55 55 55 55 55 55 55 55 55 55 55 55	5	55555 55555 55555	555 555 555	55 55 55 55
LHLL	(5)			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	555 55 5 55 5 55 5 55 5	55555 55 55 55 55 55		50 50 50 50 50 50 50 50 50 50 50 50 50 5			55 55	55555 55 55 55 55555	55 55 55 55 55 55 55 55 55 55 55 55 55	5 55 5 5 5 5 5	chardened G G G G G	10 10 10 10 10 10 10 10 10 10 10 10 10 1
LHLH	(6)						555 5555 5555 5555				55	2 5		555 5 5 5 5		6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6
LHHL	(7)				55555 5555 5555 5555 5555 5555	**************************************	55 55 55 55 55 55 55	50 50 50 50 50 50		Æ	55555 55555 5	50 50 50 50 50 50 50 50 50 50 50 50 50 5	555	55555 55555 55555		200 200 200 200 200 200 200 200 200 200
LHHH	(8)		10 15 15 15				5555 5 5 5555 555				55555 55 55	100		555 5555 5 5	555	6 6 6655 6 6 6 6 6 7 8 8 8 8 8 8 8 8 8 8 8 8 8 8
HLLL	(1)	des	5 5 5 5 5 5	555 555 555 555 555 555				5 5 5 5 5 5	act	ur	10 10 10 10 10 10		5555 5555 5555 5555	55555 55555 55555	10000 10000 10000	55555 555 555 5
HLLH	(2)		5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	555 555 555 555 55		55 55 55 55 55 55 55 55 55 55 55 55 55		50 50 50 50 50 50 50 50			55555 5 5 55	50 50 50 50 50 50 50 50 50 50 50	5 5 5 5 5	55 55 55 55 55 55 55 55 55 55 55 55 55		4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4
HLHL	(3)		5 5 5 5 5 5 5 5 5	55 55 55	555 5 5 5 5 5	55555 5 5 5 5 5 555555	5 5 5 5 5	55555 5 5 5			55555 5 55555	55555 5 5 5 5 5	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	50 50 50 50 50 50 50 50 50	6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 7 7 7 7 8 7 8	55 55 55 55 55 55 55 55 55
НЦНН	(4)		5 5 5 5 5 5	55 55 55 5	50 50 50 50 50 50 50 50 50 50 50 50 50 50	1	10 10 10 10 10 10 10 10 10 10 10 10 10 1	5 5 5 5 5 5			55555 555 555 555	555 555 555 555 555 555 555 555 555	50 50 50 50 50 50 50 50 50 50 50	50 55 5 5 5 5 5 5 5 5 5 5 5	5 5 5 5	4 4444 444 444 444 444
HHLL	(5)		55 5	55	50 50 50 50 50 50 50 50 50	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	55 55 55 55 55	10 10 10 10 10 10 10 10 10 10 10 10 10 1			55 55 55 55 55 55 55 55 55	55 5 55 5 55 5	55555 5 5 5 5	•		
HHLH	(6)		5555	55555 55555			55 55 55 55 55 55 55 55 55	5 5 5 5			555 5 5 5555	55555	5 5	55 5 5	***************************************	5 55555 5
нннг	(7)		원원 원원	5 5 5	55 55 55 55 55 55 55 55 55 55 55 55 55	5 5	5 5 5 5 5 5 5 5 5	5 5 5555 5			5555 5555 5555	55 55 55 55 55 55 55 55 55 55 55 55 55	55 55 55 55 55 55 55 55 55 55 55 55 55	5 5	000000 0 0 0 0 0 0 0 0	
нннн	(8)		5	5 5 5 5 5 5 5	55 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	55555	555 5 5 5 5 5 55	5 5 55555 5			5 5 5 5 5 5 55	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	55555	55 55 55 55 55 55	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	######################################

6.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	θ	CR≧2	0		20	ψ= 180°
	θ	CR≧2	0	_	40	ψ= 0°
	θ	CR≧2	0	_	30	ψ= 90°
	θ	CR≧2	0	_	30	ψ= 270°
Contrast Ratio	CR	_	_	3	_	_
	T rise	_	_	150	200	ms
Response Time	T fall	_	_	150	200	ms

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr , Tf)

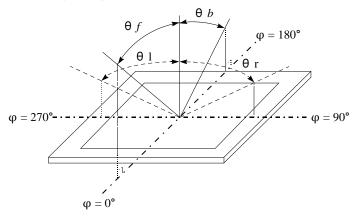


Conditions:

Operating Voltage : Vop Viewing Angle(θ , ϕ) : 0° , 0°

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle(CR≧2)



7.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	°C
Storage Temperature	Тѕт	-30	_	+80	°C
Input Voltage	Vı	Vss	_	V_{DD}	V
Supply Voltage For Logic	VDD-VSS	-0.3	_	7	V
Supply Voltage For LCD	V _{DD} -V _o	-0.3	_	13	V



design • manufacture • supply

8. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V _{DD} -V _{SS}	_	4.5	5.0	5.5	V
		Ta=-20°C	_	_	5.7	V
Supply Voltage For LCD	V_{DD} - V_0	Ta=25°C	4.1	4.2	4.3	V
* Note		Ta=70°C	3.5	_	_	V
Input High Volt.	ViH	_	0.7 V _{DD}	_	V _{DD}	V
Input Low Volt.	Vıl	_	Vss	_	0.6	V
Output High Volt.	Vон	_	3.9	_	V _{DD}	V
Output Low Volt.	Vol	_	0	_	0.4	V
Supply Current	I _{DD}	V _{DD} =5.0V		1.2	_	mA

Note: Please design the VOP adjustment circuit on customer's main board



9.Backlight Information

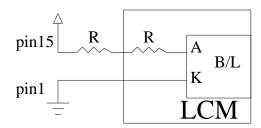
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	32	40	48	mA	V=4.2V
Supply Voltage	V	4.0	4.2	4.7	V	_
Reverse Voltage	VR	_	_	5	V	_
Luminance (Without LCD)	IV	48	60	_	CD/M ²	ILED=40mA
Wave Length	λр	565	569	575	nm	ILED=40mA
Life Time	- 1	-	100000		Hr.	ILED=40 mA 25°C,50-60%RH
Color	Yellow Gro	een				

Note: The LED of B/L is drive by current only, drive voltage is for reference only.

drive voltage can make driving current under safety area (current between minimum and maximum).

Drive from pin15,pin1



10.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage Low Temperature	Endurance test applying the high storage temperature for a long time. Endurance test applying the low storage temperature	80°C 200hrs -30°C	2
storage	for a long time.	200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°Հ90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°0/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times	

Note1: No dew condensation to be observed.

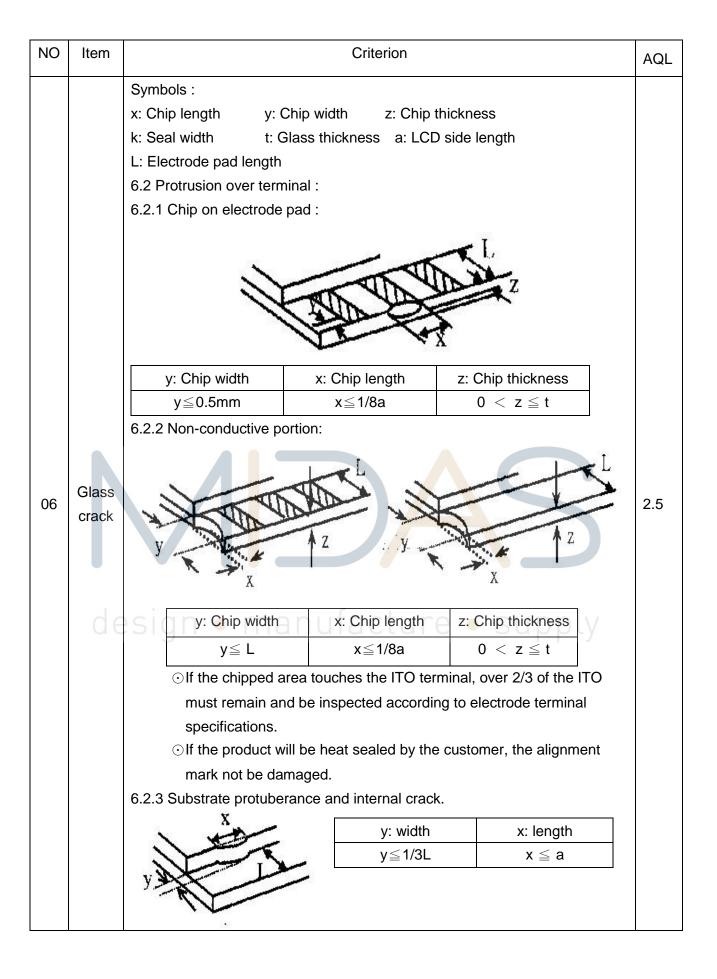
Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

11.Inspection specification

NO	Item	Criterion				
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 				0.65
02	Black or white spots on LCD (display only)	2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.2.2 Densely spaced: No more than two spots or lines within 3mm			2.5	
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As $\Phi = (x + y)/2$	Y	$\phi \leq 0.10$ $0.10 < \phi \leq 0.20$ $0.20 < \phi \leq 0.25$ $0.25 < \phi$	Acceptable Q TY Accept no dense 2 1 0	2.5
		→ L W L	followin ength ≦3.0 ≤2.5	$\begin{array}{c} \text{ width} \\ \text{W} \! \leq \! 0.02 \\ 0.02 \! < \! \text{W} \! \leq \! 0.03 \\ 0.03 \! < \! \text{W} \! \leq \! 0.05 \\ 0.05 \! < \! \text{W} \end{array}$	Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are visible judge using black some specifications, not to find, must check specify direction.	pot easy	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item	Criterion				
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
		Symbols Define:				
		x: Chip length y: 0	Chip width z: Chip	thickness		
		k: Seal width t: Glass thickness a: LCD side length				
		L: Electrode pad length:				
		6.1 General glass chip:				
		6.1.1 Chip on panel sur	face and crack betweer	n panels:		
	Chipped glass		N. C.			
		z: Chip thickness	y: Chip width	x: Chip length		
06		Z≦1/2t	Not over viewing area	x≦1/8a	2.5	
		1/2t < <mark>z</mark> ≦2t	Not exceed 1/3k	x≦1/8a	2.0	
		⊙ If there are 2 or more chips, x is total length of each chip.				
		6.1.2 Corner crack:				
	desi	gn • manı	X Z Z	ysupply		
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≦1/2t	Not over viewing area	x≦1/8a		
		1/2t < z ≦ 2t	Not exceed 1/3k	x≦1/8a		
		⊙ If there are 2 or more	chips, x is the total len	gth of each chip.		



NO	Item	Criterion	AQL	
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5	
	Backlight elements	8.1 Illumination source flickers when lit.		
08		8.2 Spots or scratched that appear when lit must be judged.		
		Using LCD spot, lines and contamination standards.		
		8.3 Backlight doesn't light or color wrong.	0.65	
	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints,		
09		stains or other contamination.		
		9.2 Bezel must comply with job specifications.	0.65	
		10.1 COB seal may not have pinholes larger than 0.2mm or		
		contamination.	2.5	
		10.2 COB seal surface may not have pinholes through to the IC.		
		10.3 The height of the COB should not exceed the height	2.5	
		indicated in the assembly diagram.	0.65	
	PCB · COB	10.4 There may not be more than 2mm of sealant outside the		
		seal a <mark>re</mark> a on the PCB. And there should be no more than	2.5	
		three <mark>pl</mark> aces.		
		10.5 No o <mark>xi</mark> dation or contamination PCB terminals.		
10		10.6 Parts on PCB must be the <mark>sa</mark> me as on the production	2.5	
		chara <mark>ct</mark> eristic chart. There <mark>s</mark> hould be no wro <mark>ng</mark> parts,		
		missing parts or excess parts.	0.65	
		10.7 The jumper on the PCB should conform to the product characteristic chart.		
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	0.65	
		screw hold pad, make sure it is smoothed down.		
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5	
		X Y	2.5	
		X * Y<=2mm2		
11	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5	
		11.2 No cold solder joints, missing solder connections, oxidation	2.5	
		or icicle.		
		11.3 No residue or solder balls on PCB.	2.5	
		11.4 No short circuits in components on PCB.	0.65	

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
	General appearance	pin must be present or look as if it cause the interface pin to	
		sever.	2.5
12		12.6 The residual rosin or tin oil of soldering (component or chip	
		component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on	0.00
		packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product	0.05
		specification sheet.	
		12.12 Vi <mark>su</mark> al defect outside of VA is not considered to be rejection.	

design • manufacture • supply

12. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.

design • manufacture • supply

13. Material List of Components for RoHs

1. Midas. hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

2.Process for RoHS requirement : (only for RoHS inspection)

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250°C30 seconds Max.;

Connector soldering wave or hand soldering: 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

14. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

